where σ_0 is the yield stress at the onset of plastic strain, b is the slope, and ε is the effective strain in the plastic region. An inherent implication here is that the wafer material be rigid until the incipience of plastic strain, and then strains in a linear fashion. Thus, the small elastic strains occurring in the wafer are neglected. The effective strain ε for a material that is rigid up to yield is given in Reference (f), and when combined with equation (4) can be written as

$$\overline{\epsilon} = \frac{\sqrt{2}}{3} \left[(\epsilon_{r} - \epsilon_{\theta})^{2} + (\epsilon_{\theta} - \epsilon_{\underline{z}})^{2} + (\epsilon_{\underline{z}} - \epsilon_{r})^{2} + \frac{3}{2} \gamma_{r\underline{z}}^{2} \right]^{2} (10)$$

The von Mises yield theory is thus a combination of equations (8), (9), and (10).

The two equilibrium equations for cylindrical coordinates are easily developed from the stress state acting on a differential volume element taken from the wafer in the loaded state. They are

$$\frac{\partial \sigma_r}{\partial r} + \frac{\sigma_r - \sigma_o}{r} + \frac{\partial \sigma_r}{\partial z} = 0 \quad (11)$$

$$\frac{\partial Trz}{\partial r} + \frac{\partial Gz}{\partial Z} + \frac{Trz}{r} = 0 \quad (12)$$